

OPTIONAL EQUIPMENT LIST

	Unit item
Injection	Long nozzle(tip type)
	SVN shut-off nozzle (spring type)
	KK size (245MPa) screw cylinder (for J180ELIII and smaller)
	K size (216MPa) screw cylinder (for J220ELIII and up)
	Wear and corrosion-resistant screw
	Screw for optical parts molding
	High-melter M7 screw (except J35ELIII)
	HT Screw head
	High temperature molding device for super engineering plastics
	Cylinder heat insulating cover
	Cylinder module system
	Hopper flange temperature control
	High-speed injection (standard for J35ELIII, J450ELIII-1400H)
Mold Clamping unit	Daylight extension
	Mold platen heat insulating plate ¹⁾
	Air jet
	Pneumatic core puller circuit
	Unscrewing motor control circuit
	Gate-cut circuit
	Photocell type product drop confirmation
	Product drop confirmation signal connection circuit
	Ejector plate return confirmation circuit
	Chute
	Reject discriminating chute
	Mold mounting preparation unit
	2 lubrication lines for mold clamping and injection unit
Controller and Others	Language switching function ²⁾
	Alarm light
	Communication function with host computer
	Printer (with printer cable)
	Printer cable (IBM compatible)
Data card (40 sets mold/card)	

Notes:

- 1) Please consider a stroke of nozzle with a thickness of heat insulating plates when plates are putting.
- 2) One more language can be added, in addition to Japanese and English.